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(54) **TAPE WITH EMBEDDED IC CHIP AND SHEET WITH EMBEDDED IC CHIP**

(57) A sheet with a built-in IC chip in which mechanical external forces do not significantly impinge on the IC chip and the IC chip does not separate or become dam-

aged, and a tape with a built-in IC chip used for the sheet with a built-in IC chip. In the tape with a built-in IC chip, a part or all of the IC chip is embedded in a tape body.

FIG.1

